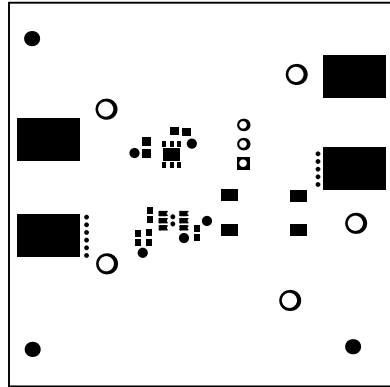
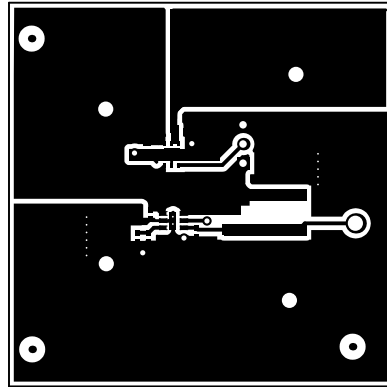


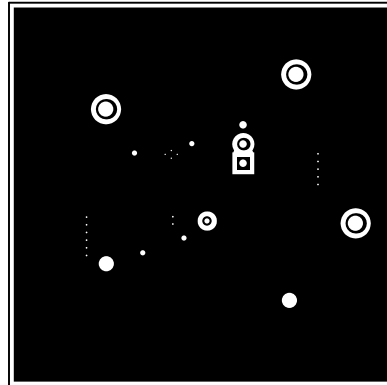
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00720	REV: A	SVN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 10/2/2015 6:01:00 PM	TEXAS INSTRUMENTS	



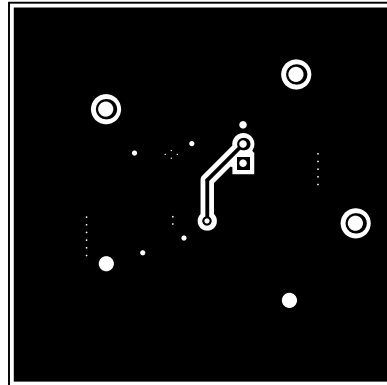
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00720	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 10/2/2015 6:01:01 PM	TEXAS INSTRUMENTS	



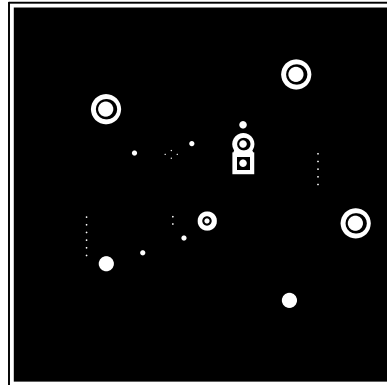
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00720	REV: A	SUN REV: Not In VersionControl
LAYER NAME = L1<TOP>			
PLOT NAME = Top Layer	GENERATED : 10/2/2015 6:01:01 PM	TEXAS INSTRUMENTS	



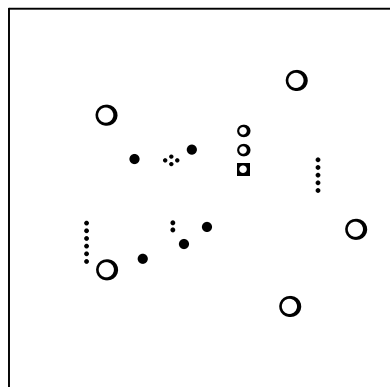
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00720	REV: A	SUN REV: Not In VersionControl
LAYER NAME =			
PLOT NAME = Signal Layer 1	GENERATED : 10/2/2015 6:01:02 PM	TEXAS INSTRUMENTS	



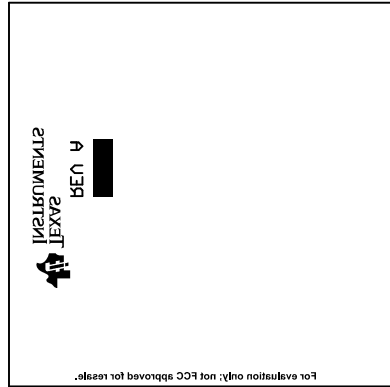
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00720	REV: A	SUN REV: Not In VersionControl
LAYER NAME =			
PLOT NAME = Signal Layer 2	GENERATED : 10/2/2015 6:01:03 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00720	REV: A	SUN REV: Not In VersionControl
LAYER NAME = L4(BOT)			
PLOT NAME = Bottom Layer	GENERATED : 10/2/2015 6:01:03 PM	TEXAS INSTRUMENTS	

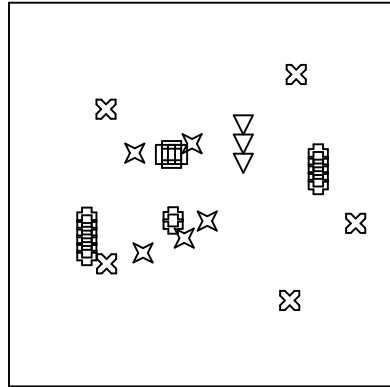


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00720	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 10/2/2015 6:01:04 PM	TEXAS INSTRUMENTS	



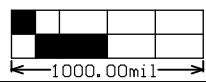
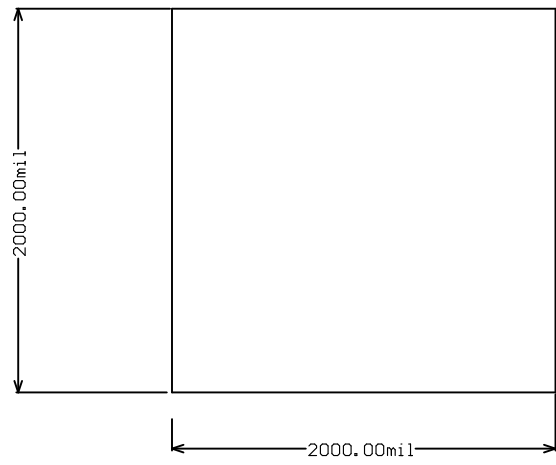
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00720	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 10/2/2015 6:01:05 PM	TEXAS INSTRUMENTS	





Symbol	Quantity	Finished Hole Size	Plated	Hole Type
□	4	7.87mil (0.200mm)	PTH	Round
⊗	13	10.00mil (0.254mm)	PTH	Round
✱	5	28.00mil (0.711mm)	PTH	Round
▽	3	40.00mil (1.016mm)	PTH	Round
⊗	5	80.71mil (2.050mm)	PTH	Round
	30 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00720	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 10/2/2015 6:01:06 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00720	REV: A	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 10/2/2015 6:01:06 PM	TEXAS INSTRUMENTS	

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